1 Form **PTO-1595** (Rev. 09/08) OMB No. 0651-0027 (Exp. 10/31/2008)

12-30-2008



U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office FLH Ref. No.: 450100-06167

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12/29/08 103541653 EET PATENTS ONLY				
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.				
1. Name of conveying party(ies) Hiroyuki SUZUKI, Toshifumi NOMURA Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	2. Name and address of receiving party(ies) SONY CORPORATION 1-7-1 Konan, Minato-ku Tokyo, 108-0075, Japan			
3. Nature of conveyance/Execution Date(s): Execution Date(s): December 9, 2008 Assignment	Additional name(s) & address(es) attached? ☐ Yes ☒ No			
4. Application or patent number(s): A. Patent Application No.(s) 12/249,138 filed October 10, 2008 Additional numbers att	This document is being filed together with a new application. B. Patent No.(s) ached? Yes No			
5. Name and address to whom correspondence	6. Total number of applications and patents involved: 1			
Name: William S. Frommer Internal Address: Frommer Lawrence & Haug LLP Street Address: 745 Fifth Avenue City: New York State: NY Zip: 10151	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00 Authorized to be charged by credit card Authorized to be charged to deposit account 50-0320 Enclosed None required (government interest not affecting title)			
Phone Number: (212) 588-0800 Fax Number: (212) 588-0500 E-mail Address: WFrommer@flhlaw.com	8. Payment Information a. Credit Card Last 4 Numbers Expiration date b. Deposit Account Number 50-0320 Authorized User Name			
9. Signature: Signature Thomas F. Presson, Reg. No. Name of Person Signing	best standard and documents: [/]			

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

> 00000105 12545136 12/29/2008 #JAMA1 01 FC:8021 40.98 00

FLH Docket Number: 450100-06167

ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

TOUCH SENSOR

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese Corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, 108-0075, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/249,138, Filing Date: October 10, 2008.

This assignment executed on the dates indicated below.

Hiroyuki SUZUKI			
Name of sole or 1st inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of sole or 1st inventor			
Hiroyaki Suzuki	December 9, 2008		
Signature of sole or 1st inventor	Date of this assignment		
Toshifumi NOMURA			
Name of 2nd joint inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of 2nd joint inventor	b 1 0 50		
Toshifumi Nomura	December 9, 2008		
Signature of 2nd joint inventor	Date of this assignment		

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REEL: 022054 FRAME: 0613

RECORDED: 12/29/2008